

6A, 18V, 650kHz, ACOT[™] Synchronous Step-Down Converter

General Description

The RT6236A/B is a high-performance 650kHz, 6A stepdown regulator with internal power switches and synchronous rectifiers. It features quick transient response using its Advanced Constant On-Time (ACOTTM) control architecture that provides stable operation with small ceramic output capacitors and without complicated external compensation, among other benefits. The input voltage range is from 4.5V to 18V and the output is adjustable from 0.7V to 8V. The proprietary ACOTTM control improves upon other fast response constant on-time architectures, achieving nearly constant switching frequency over line, load, and output voltage ranges. Since there is no internal clock, response to transients is nearly instantaneous and inductor current can ramp quickly to maintain output regulation without large bulk output capacitance. The RT6236A/B is stable with and optimized for ceramic output capacitors. With internal $51m\Omega$ switches and $18m\Omega$ synchronous rectifiers, the RT6236A/B displays excellent efficiency and good behavior across a range of applications, especially for low output voltages and low duty cycles. Cycle-by-cycle current limit provides protection against shorted outputs, input under-voltage lock-out, externally-adjustable soft-start, output under- and over-voltage protection, and thermal shutdown provide safe and smooth operation in all operating conditions. The RT6236A/B is available in the UQFN-13JL 2x3 (FC) package, with exposed thermal pad.

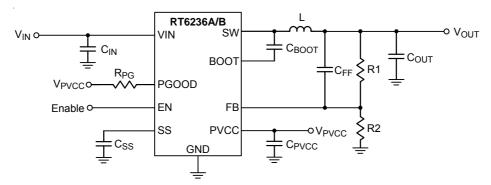
Features

- Fast Transient Response
- Advanced Constant On-Time (ACOT[™]) Control
- 4.5V to 18V Input Voltage Range
- Adjustable Output Voltage from 0.7V to 8V
- 6A Output Current
- \bullet 51m Ω Internal High-Side N-MOSFET and 18m Ω Internal Low-Side N-MOSFET
- Steady 650kHz Switching Frequency
- Up to 95% Efficiency
- Optimized for All Ceramic Capacitors
- Externally-Adjustable, Pre-biased Compatible Soft-
- Cycle-by-Cycle Current Limit
- Input Under-Voltage Lockout
- Output Over- and Under-Voltage Protection
- Power Good Output
- Externally-Adjustable, Pre-biased Compatible Soft-
- Thermal Shutdown

Applications

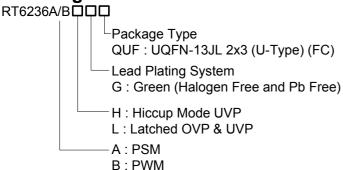
- Industrial and Commercial Low Power Systems
- Computer Peripherals
- LCD Monitors and TVs
- Green Electronics/Appliances
- Point of Load Regulation for High-Performance DSPs, FPGAs, and ASICs

Simplified Application Circuit





Ordering Information

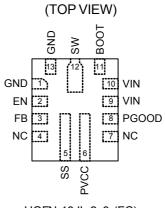


Note:

Richtek products are:

- > RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Pin Configuration



UQFN-13JL 2x3 (FC)

Marking Information

RT6236AHGQUF



0Z: Product Code

W: Date Code

RT6236ALGQUF



0Y: Product Code

W: Date Code

RT6236BHGQUF



0X: Product Code

W: Date Code

RT6236BLGQUF



0W: Product Code

W: Date Code

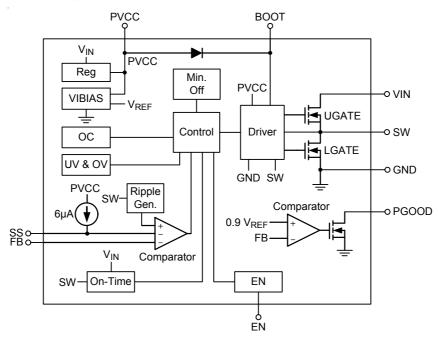
Functional Pin Description

Pin No.	Pin Name	Pin Function
1, 13	GND	Ground.
2	EN	Enable control input.
3	FB	Converter feedback input. Connect to output voltage feedback resistor divider.
4, 7	NC	No internal connection.
5	SS	Soft-start control. A external capacitor should be connected to GND.
6	PVCC	5V power supply output. A capacitor (typical 1μF) should be connected to GND.
8	PGOOD	Open drain power good output.
9, 10	VIN	Power input and connected to high-side MOSFET drain.
11	воот	Bootstrap. This capacitor is needed to drive the power switch's gate above the supply voltage. It is connected between SW and BOOT pins to form a floating supply across the power switch driver. A $0.1\mu F$ capacitor is recommended for use.
12	SW	Switch output.

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Functional Block Diagram



Detailed Description

The RT6236A/B is a high-performance 650kHz 6A step-down regulators with internal power switches and synchronous rectifiers. It features an Advanced Constant On-Time (ACOTTM) control architecture that provides stable operation with ceramic output capacitors without complicated external compensation, among other benefits. The ACOTTM control mode also provide fast transient response, especially for low output voltages and low duty cycles.

The input voltage range is from 4.5V to 18V and the output is adjustable from 0.7V to 8V. The proprietary ACOTTM control scheme improves upon other constant on-time architectures, achieving nearly constant switching frequency over line, load, and output voltage ranges. The RT6236A/B are optimized for ceramic output capacitors. Since there is no internal clock, response to transients is nearly instantaneous and inductor current can ramp quickly to maintain output regulation without large bulk output capacitance.

Constant On-Time (COT) Control

The heart of any COT architecture is the on-time one shot. Each on-time is a pre-determined "fixed" period that is triggered by a feedback comparator. This robust

arrangement has high noise immunity and is ideal for low duty cycle applications. After the on-time one-shot period, there is a minimum off-time period before any further regulation decisions can be considered. This arrangement avoids the need to make any decisions during the noisy time periods just after switching events, when the switching node (SW) rises or falls. Because there is no fixed clock, the high-side switch can turn on almost immediately after load transients and further switching pulses can ramp the inductor current higher to meet load requirements with minimal delays.

Traditional current mode or voltage mode control schemes typically must monitor the feedback voltage, current signals (also for current limit), and internal ramps and compensation signals, to determine when to turn off the high-side switch and turn on the synchronous rectifier. Weighing these small signals in a switching environment is difficult to do just after switching large currents, making those architectures problematic at low duty cycles and in less than ideal board layouts.

Because no switching decisions are made during noisy time periods, COT architectures are preferable in low duty cycle and noisy applications. However, traditional COT



control schemes suffer from some disadvantages that preclude their use in many cases. Many applications require a known switching frequency range to avoid interference with other sensitive circuitry. True constant on-time control, where the on-time is actually fixed, exhibits variable switching frequency. In a step-down converter, the duty factor is proportional to the output voltage and inversely proportional to the input voltage. Therefore, if the on-time is fixed, the off-time (and therefore the frequency) must change in response to changes in input or output voltage.

Modern pseudo-fixed frequency COT architectures greatly improve COT by making the one-shot on-time proportional to VOUT and inversely proportional to VIN. In this way, an on-time is chosen as approximately what it would be for an ideal fixed-frequency PWM in similar input/output voltage conditions. The result is a big improvement but the switching frequency still varies considerably over line and load due to losses in the switches and inductor and other parasitic effects.

Another problem with many COT architectures is their dependence on adequate ESR in the output capacitor, making it difficult to use highly-desirable, small, low-cost, but low-ESR ceramic capacitors. Most COT architectures use AC current information from the output capacitor, generated by the inductor current passing through the ESR, to function in a way like a current mode control system. With ceramic capacitors the inductor current information is too small to keep the control loop stable, like a current mode system with no current information.

ACOT[™] Control Architecture

Making the on-time proportional to VOUT and inversely proportional to VIN is not sufficient to achieve good constant-frequency behavior for several reasons. First, voltage drops across the MOSFET switches and inductor cause the effective input voltage to be less than the measured input voltage and the effective output voltage to be greater than the measured output voltage. As the load changes, the switch voltage drops change causing a switching frequency variation with load current. Also, at light loads if the inductor current goes negative, the switch dead-time between the synchronous rectifier turn-off and the high-side switch turn-on allows the switching node to rise to the input voltage. This increases the effective on time and causes the switching frequency to drop noticeably.

One way to reduce these effects is to measure the actual switching frequency and compare it to the desired range. This has the added benefit eliminating the need to sense the actual output voltage, potentially saving one pin connection. ACOTTM uses this method, measuring the actual switching frequency and modifying the on-time with a feedback loop to keep the average switching frequency in the desired range.

To achieve good stability with low-ESR ceramic capacitors, ACOTTM uses a virtual inductor current ramp generated inside the IC. This internal ramp signal replaces the ESR ramp normally provided by the output capacitor's ESR.

The ramp signal and other internal compensations are optimized for low-ESR ceramic output capacitors.

ACOT™ One-Shot Operation

The RT6236A/B control algorithm is simple to understand. The feedback voltage, with the virtual inductor current ramp added, is compared to the reference voltage. When the combined signal is less than the reference and the ontime one-shot is triggered, as long as the minimum offtime one-shot is clear and the measured inductor current (through the synchronous rectifier) is below the current limit. The on-time one-shot turns on the high-side switch and the inductor current ramps up linearly. After the on time, the high-side switch is turned off and the synchronous rectifier is turned on and the inductor current ramps down linearly. At the same time, the minimum off-time one-shot is triggered to prevent another immediate on-time during the noisy switching time and allow the feedback voltage and current sense signals to settle. The minimum off-time is kept short (230ns typical) so that rapidly-repeated ontimes can raise the inductor current quickly when needed.

Discontinuous Operating Mode (RT6236A Only)

After soft-start, the RT6236A operates in fixed frequency mode to minimize interference and noise problems. The RT6236A uses variable-frequency discontinuous switching at light loads to improve efficiency. During discontinuous switching, the on-time is immediately increased to add

"hysteresis" to discourage the IC from switching back to continuous switching unless the load increases substantially.

The IC returns to continuous switching as soon as an ontime is generated before the inductor current reaches zero. The on-time is reduced back to the length needed for 650kHz switching and encouraging the circuit to remain in continuous conduction, preventing repetitive mode transitions between continuous switching and discontinuous switching.

Current Limit

The RT6236A/B current limit is a cycle-by-cycle "valley" type, measuring the inductor current through the synchronous rectifier during the off-time while the inductor current ramps down. The current is determined by measuring the voltage between source and drain of the synchronous rectifier. If the inductor current exceeds the current limit, the on-time one-shot is inhibited (Mask high side signal) until the inductor current ramps down below the current limit. Thus, only when the inductor current is well below the current limit is another on time permitted. This arrangement prevents the average output current from greatly exceeding the guaranteed current limit value, as typically occurs with other valley-type current limits. If the output current exceeds the available inductor current (controlled by the current limit mechanism), the output voltage will drop. If it drops below the output under-voltage protection level, the IC will stop switching (see next section).

Output Over-Voltage Protection and Under-Voltage Protection

If the output voltage V_{OUT} rises above the regulation level and lower 1.2 times regulation level, the high-side switch naturally remains off and the synchronous rectifier turns on. For the RT6236B, if the output voltage remains high the synchronous rectifier remains on until the inductor current reaches the low side current limit. If the output voltage still remains high, then IC's switches remain that the synchronous rectifier turns on and high-side MOS keeps off to operate at typical 500kHz switching protection, again if inductor current reaches low side current, the synchronous rectifier will turn off until next protection

clock. If the output voltage exceeds the OVP trip threshold (1.25 times regulation level) for longer than $10\mu s$ (typical), then IC's output Over-Voltage Protection (OVP) is triggered. The RT6236BL chip enters latch mode.

For the RT6236A If the output voltage V_{OUT} rises above the regulation level and lower 1.2 times regulation level, the high-side switch naturally remains off and the synchronous rectifier turns on until the inductor current reaches zero current. If the output voltage remains high, then IC's switches remain off. If the output voltage exceeds the OVP trip threshold (1.25 times regulation level) for longer than $10\mu s$ (typical), the IC's OVP is triggered. The RT6236AL chip enters latch mode.

The RT6236A/B include output Under-Voltage Protection (UVP). If the output voltage drops below the UVP trip threshold for longer than 250 μ s (typical) then IC's UVP is triggered. Chip into latch or hiccup mode. (see next section).

Hiccup Mode

The RT6236AH/BH, use hiccup mode for UVP. When the protection function is triggered, the IC will shut down for a period of time and then attempt to recover automatically. Hiccup mode allows the circuit to operate safely with low input current and power dissipation, and then resume normal operation as soon as UVP is removed. During hiccup mode, the shutdown time is determined by the capacitor at SS. A 2µA current source discharges V_{SS} from its starting voltage (normally V_{PVCC}). The IC remains shut down until V_{SS} reaches 0.2V, about 10ms for a 3.9nF capacitor. At that point the IC begins to charge the SS capacitor at 6µA, and a normal start-up occurs. If the fault remains, UVP protection will be enabled when V_{SS} reaches 2.2V (typical). The IC will then shut down and discharge the SS capacitor from the 2.2V level, taking about 4ms for a 3.9nF SS capacitor.

Latch-Off Mode

The RT6236AL/BL, use latch-off mode OVP and UVP. When the protection function is triggered the IC will shut down in Latch-Off Mode. The IC stops switching, leaving both switches open, and is latched off. To restart operation, toggle EN or power the IC off and then on again.



Shut-down, Start-Up and Enable (EN)

The enable input (EN) has a logic-low level of 0.4V. When V_{EN} is below this level the IC enters shutdown mode and supply current drops to less than $10\mu A$. When V_{EN} exceeds its logic-high level of 2V the IC is fully operational.

Between these 2 levels there are 2 thresholds (1.2V typical and 1.4V typical). When V_{EN} exceeds the lower threshold the internal bias regulators begin to function and supply current increases above the shutdown current level. Switching operation begins when V_{EN} exceeds the upper threshold. Unlike many competing devices, EN is a high voltage input that can be safely connected to VIN (up to 18V) for automatic start-up.

Input Under-Voltage Lock-Out

In addition to the enable function, the RT6236A/B feature an Under-Voltage Lock-Out (UVLO) function that monitors the internal linear regulator output (VIN). To prevent operation without fully-enhanced internal MOSFET switches, this function inhibits switching when VIN drops below the UVLO-falling threshold. The IC resumes switching when VIN exceeds the UVLO-rising threshold.

Soft-Start (SS)

The RT6236A/B soft-start uses an external pin (SS) to clamp the output voltage and allow it to slowly rise. After V_{EN} is high and VIN exceeds its UVLO threshold, the IC begins to source 6µA from the SS pin. An external capacitor at SS is used to adjust the soft-start timing. Following below equation to get the minimum capacitance range in order to avoid UV occur.

$$T = \frac{C_{OUT} \times V_{OUT} \times 0.6 \times 1.2}{(I_{LIM} - Load Current) \times 0.8}$$

$$T \times 6 \mu \Delta$$

$$C_{SS} \geq \frac{T \times 6 \mu A}{V_{REF}}$$

Do not leave SS unconnected. During start-up, while the SS capacitor charges, the RT6236A/B operates in discontinuous switching mode with very small pulses. This prevents negative inductor currents and keeps the circuit from sinking current. Therefore, the output voltage may be pre-biased to some positive level before start-up. Once the V_{SS} ramp charges enough to raise the internal reference above the feedback voltage, switching will begin and the output voltage will smoothly rise from the pre-biased level

to its regulated level. After V_{SS} rises above about 2.2V output over- and under-voltage protections are enabled and the RT6236A/B begins continuous-switching operation.

Internal Regulator (PVCC)

An internal linear regulator (PVCC) produces a 5V supply from VIN. The 5V power supplies the internal control circuit, such as internal gate drivers, PWM logic, reference, analog circuitry, and other blocks. 1µF ceramic capacitor for decoupling and stability is required.

PGOOD Comparator

PGOOD is an open-drain output controlled by a comparator connected to the feedback signal. If FB exceeds 90% of the internal reference voltage or OVP event is cleared, PGOOD will be high impedance. Otherwise, the PGOOD output is connected to GND.

External Bootstrap Capacitor (C_{BOOT})

Connect a 0.1µF low ESR ceramic capacitor between BOOT and SW. This bootstrap capacitor provides the gate driver supply voltage for the high-side N-channel MOSFET switch.

Some of case, such like duty ratio is higher than 65% application or input voltage is lower than 5.5V which are recommended to add an external bootstrap diode between an external 5V and BOOT pin for efficiency improvement The bootstrap diode can be a low cost one such as IN4148 or BAT54. The external 5V can be a 5V fixed input from system or a 5V output of the RT6236A/B. Note that the external boot voltage must be lower than 5.5V

Over-Temperature Protection

The RT6236A/B includes an Over-Temperature Protection (OTP) circuitry to prevent overheating due to excessive power dissipation. The OTP will shut down switching operation when the junction temperature exceeds 150°C. Once the junction temperature cools down by approximately 20°C the IC will resume normal operation with a complete soft-start. For continuous operation, provide adequate cooling so that the junction temperature does not exceed 150°C.



Absolute Maximum Ratings (Note 1)

• Supply Voltage, VIN	-0.3V to 21V
• Switch Voltage, SW	$-0.3V$ to $(V_{IN} + 0.3V)$
• Switch Voltage, <100ns	$-9V$ to $(V_{IN} + 0.3V)$
• BOOT Voltage	-0.3V to 27.3V
• BOOT to SW, <100ns	
• EN to GND	-0.3V to 6V
• Other Pins	-0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
UQFN-13JL 2x3 (FC)	1.54W
Package Thermal Resistance (Note 2)	
UQFN-13JL 2x3 (FC), θ_{JA}	
UQFN-13JL 2x3 (FC), θ_{JC}	7.3°C/W
Junction Temperature Range	150°C
• Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV

Recommended Operating Conditions (Note 4)

•	Supply Voltage, VINSupply Voltage, VIN	4.5V to 18V
•	Junction Temperature Range	-40°C to 125°C
•	Ambient Temperature Range	–40°C to 85°C

Electrical Characteristics

 $(V_{IN}$ = 12V, T_A = -40°C to 85°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Supply Voltage							
VIN Supply Input Operating Voltage	V _{IN}		4.5		18	V	
Under-Voltage Lockout Threshold	V _{UVLO}		4	4.2	4.4	V	
Under-Voltage Lockout Threshold Hysteresis	ΔV _{UVLO}			0.5		V	
Shutdown Current	I _{SHDN}	V _{EN} = 0V		1.5	10	μΑ	
Quiescent Current	IQ	$V_{EN} = 2V, V_{FB} = 0.7V$		0.8	1.2	mA	
Enable Voltage	Enable Voltage						
Enable Voltage Threshold		V _{EN} rising	1.1	1.2	1.3	V	
Enable Voltage Hysteresis				200		mV	
Feedback Voltage							
Feedback Voltage Threshold	V _{FB}	$4.5V \leq V_{IN} \leq 18V$	0.693	0.7	0.707	V	
Feedback Input Current	I _{FB}	V _{FB} = 0.71V	-0.1		0.1	μΑ	

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
PVCC Output						
PVCC Output Voltage	VPVCC	6V ≤ V _{IN} ≤ 18V, 0 < I _{PVCC} < 5mA		5		V
PVCC Line Regulation		6V ≤ V _{IN} ≤ 18V, I _{PVCC} = 5mA			20	\/
PVCC Load Regulation		0 < I _{PVCC} < 20mA			100	mV
PVCC Output Current	IPVCC	V _{IN} = 6V, V _{PVCC} = 4V, T _A = 25°C		150		mA
Internal MOSFET						
High-Side On-Resistance	RDS(ON)_H	V _{BOOT} – V _{SW} = 5V		51		
Low-Side On-Resistance	RDS(ON)_L			18		mΩ
Current Limit						
Low-Side Switch Valley Current Limit	ILIM		6.6	7.7	8.9	А
Thermal Shutdown	•					
Thermal Shutdown Threshold	T _{SD}			150		00
Thermal Shutdown Hysteresis	ΔT_{SD}			20		°C
On-Time Timer Control						
On-Time	ton	V _{OUT} = 1.2V		153		
Minimum On-Time	ton_min			60		ns
Minimum Off-Time	toff_MIN			230		
Soft-Start						
Internal Charge Current		V _{SS} = 0V	5	6	7	μА
Power Good						
PGOOD Good Rising		V _{FB} rising (Good)	85	90	95	
Threshold		V _{FB} rising (Fault)		120	1	%V _{FB}
PGOOD Good Falling		V _{FB} falling (Good)		112	1] /0 V FB
Threshold		V _{FB} falling (Fault)		80	1	
PGOOD Sink Current		PGOOD = 0.1V	10	20	1	mA
Output Under Voltage and Ov	ver Voltage F	Protections				
OVP Trip Threshold		OVP detect	115	120	125	%V _{FB}
OVP Propagation Delay				10		μS
UVP Trip Threshold		UVP detect	55	60	65	%V _{FB}
Ovi Trip Trii estiloiu		Hysteresis		10		\0 v FB
UVP Propagation Delay				250		μS
UVP Enable Delay		Relative to soft-start time		t _{SS} x 1.7	1	ms

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25^{\circ}C$ on a highly thermal conductive 4-Layer test board. θ_{JC} is measured at the top of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.



Typical Application Circuit

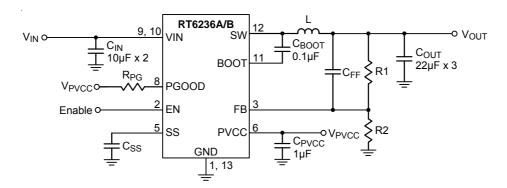
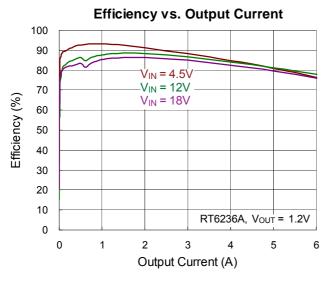


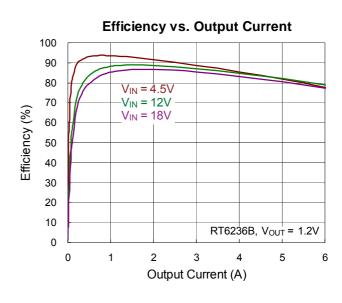
Table 1. Suggested Component Values (V_{IN} = 12V)

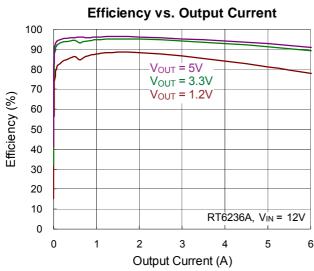
V _{OUT} (V)	R1 (k Ω)	R2 (k Ω)	L (μ H)	C _{OUT} (μ F)	C _{FF} (pF)
1	10.2	24	1	66	
1.2	17	24	1	66	
1.8	37.4	24	2	66	
2.5	61.9	24	2	66	22
5	147	24	3.3	66	22

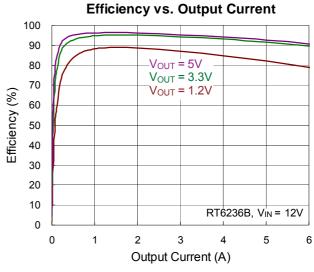


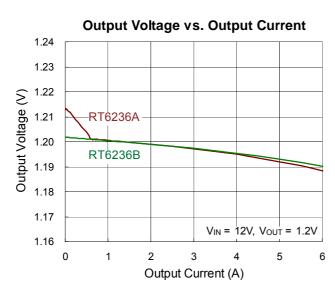
Typical Operating Characteristics

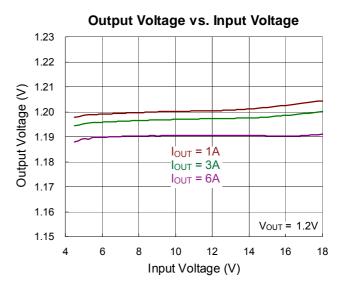




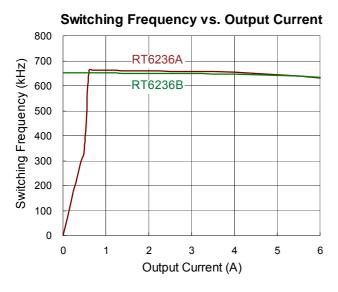


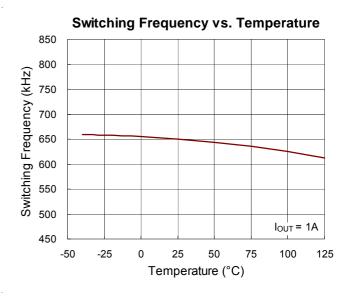


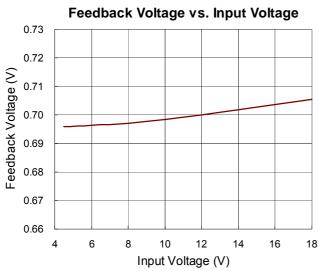


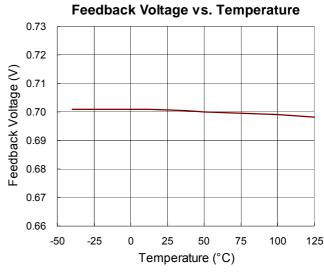


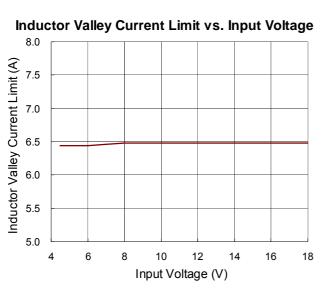


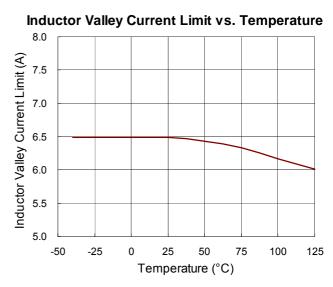




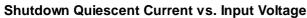


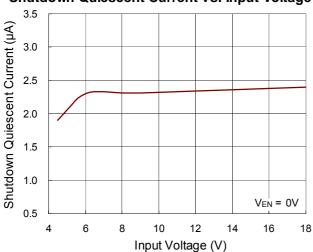




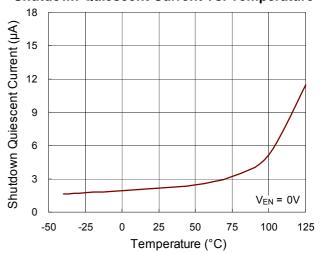




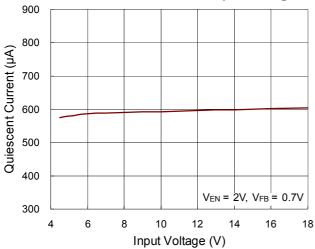




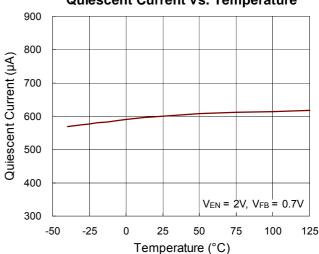
Shutdown Quiescent Current vs. Temperature



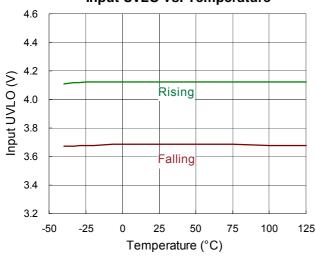
Quiescent Current vs. Input Voltage



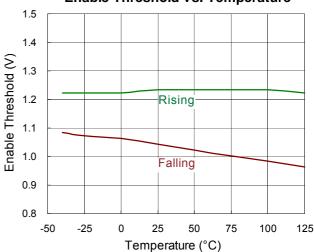
Quiescent Current vs. Temperature



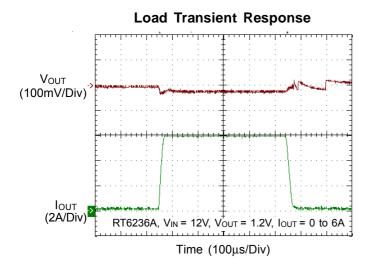
Input UVLO vs. Temperature

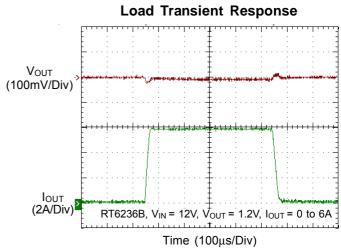


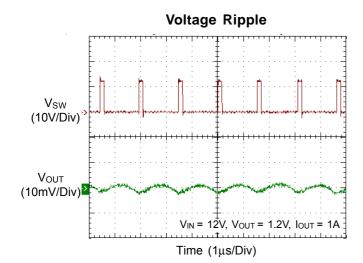
Enable Threshold vs. Temperature

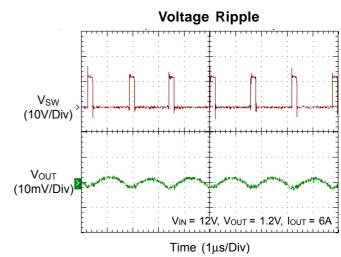


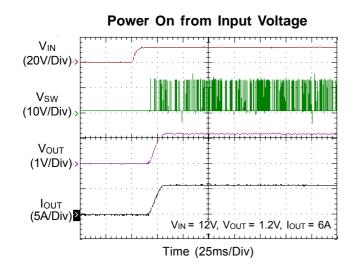


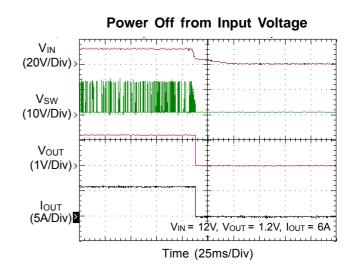


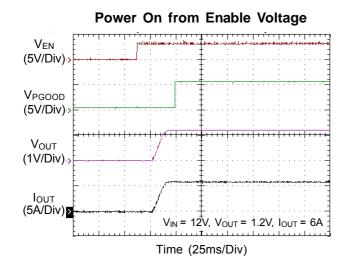


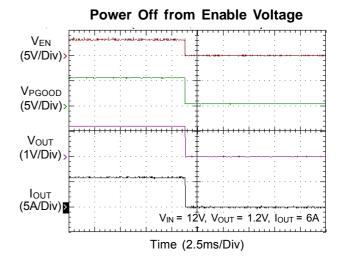














Application information

Inductor Selection

Selecting an inductor involves specifying its inductance and also its required peak current. The exact inductor value is generally flexible and is ultimately chosen to obtain the best mix of cost, physical size, and circuit efficiency. Lower inductor values benefit from reduced size and cost and they can improve the circuit's transient response, but they increase the inductor ripple current and output voltage ripple and reduce the efficiency due to the resulting higher peak currents. Conversely, higher inductor values increase efficiency, but the inductor will either be physically larger or have higher resistance since more turns of wire are required and transient response will be slower since more time is required to change current (up or down) in the inductor. A good compromise between size, efficiency, and transient response is to use a ripple current (ΔI_{\perp}) about 20% to 50% of the desired full output load current. Calculate the approximate inductor value by selecting the input and output voltages, the switching frequency (f_{SW}), the maximum output current (I_{OUT(MAX)}) and estimating a ΔI_L as some percentage of that current.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times \Delta I_{L}}$$

Once an inductor value is chosen, the ripple current (ΔI_{L}) is calculated to determine the required peak inductor current.

$$\Delta I_L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times L}$$
 and $I_{L(PEAK)} = I_{OUT(MAX)} + \frac{\Delta I_L}{2}$

To guarantee the required output current, the inductor needs a saturation current rating and a thermal rating that exceeds $I_{L(PEAK)}$. These are minimum requirements. To maintain control of inductor current in overload and short circuit conditions, some applications may desire current ratings up to the current limit value. However, the IC's output under-voltage shutdown feature make this unnecessary for most applications.

 $I_{L(PEAK)}$ should not exceed the minimum value of IC's upper current limit level or the IC may not be able to meet the desired output current. If needed, reduce the inductor ripple current (ΔI_L) to increase the average inductor current (and the output current) while ensuring that $I_{L(PEAK)}$ does not exceed the upper current limit level.

For best efficiency, choose an inductor with a low DC resistance that meets the cost and size requirements. For low inductor core losses some type of ferrite core is usually best and a shielded core type, although possibly larger or more expensive, will probably give fewer EMI and other noise problems.

Considering the Typical Operating Circuit for 1.2V output at 6A and an input voltage of 12V, using an inductor ripple of 1.2A (20%), the calculated inductance value is:

$$L = \frac{1.2 \times (12 - 1.2)}{12 \times 650 \text{kHz} \times 1.2A} = 1.38 \mu \text{H}$$

The ripple current was selected at 1.2A and, as long as we use the calculated 1.5 μ H inductance, that should be the actual ripple current amount. The ripple current and required peak current as below :

$$\Delta I_L = \frac{1.2 \times (12 - 1.2)}{12 \times 650 \text{kHz} \times 1.5 \mu \text{H}} = 1.108 \text{A}$$

and
$$I_{L(PEAK)} = 6A + \frac{1.108A}{2} = 6.554A$$

For the $1.5\mu H$ value, the inductor's saturation and thermal rating should exceed at least 6.554A. For more conservative, the rating for inductor saturation current must be equal to or greater than switch current limit of the device rather than the inductor peak current.

Input Capacitor Selection

The input filter capacitors are needed to smooth out the switched current drawn from the input power source and to reduce voltage ripple on the input. The actual capacitance value is less important than the RMS current rating (and voltage rating, of course). The RMS input ripple current (I_{RMS}) is a function of the input voltage, output voltage, and load current:

$$I_{RMS} = I_{OUT(MAX)} \times \frac{V_{OUT}}{V_{IN}} \sqrt{\frac{V_{IN}}{V_{OUT}}} - 1$$

Ceramic capacitors are most often used because of their low cost, small size, high RMS current ratings, and robust surge current capabilities. However, take care when these capacitors are used at the input of circuits supplied by a wall adapter or other supply connected through long, thin wires. Current surges through the inductive wires can induce ringing at the RT6236A/B input which could



potentially cause large, damaging voltage spikes at VIN. If this phenomenon is observed, some bulk input capacitance may be required. Ceramic capacitors (to meet the RMS current requirement) can be placed in parallel with other types such as tantalum, electrolytic, or polymer (to reduce ringing and overshoot).

Choose capacitors rated at higher temperatures than required. Several ceramic capacitors may be paralleled to meet the RMS current, size, and height requirements of the application. The typical operating circuit uses two $10\mu F$ and one $0.1\mu F$ low ESR ceramic capacitors on the input.

Output Capacitor Selection

The RT6236A/B are optimized for ceramic output capacitors and best performance will be obtained using them. The total output capacitance value is usually determined by the desired output voltage ripple level and transient response requirements for sag (undershoot on positive load steps) and soar (overshoot on negative load steps).

Output Ripple

Output ripple at the switching frequency is caused by the inductor current ripple and its effect on the output capacitor's ESR and stored charge. These two ripple components are called ESR ripple and capacitive ripple. Since ceramic capacitors have extremely low ESR and relatively little capacitance, both components are similar in amplitude and both should be considered if ripple is critical.

VRIPPLE = VRIPPLE(ESR) + VRIPPLE(C)

$$V_{RIPPLE(ESR)} = \Delta I_L \times R_{ESR}$$

$$V_{RIPPLE(C)} = \frac{\Delta I_L}{8 \times C_{OUT} \times f_{SW}}$$

For the Typical Operating Circuit for 1.2V output and an inductor ripple of 1.108A, with 3 x 22µF output capacitance each with about $5m\Omega$ ESR including PCB trace resistance, the output voltage ripple components are:

$$V_{RIPPLE(ESR)} = 1.108A \times 5m\Omega = 5.54mV$$

$$V_{RIPPLE(C)} = \frac{1.108A}{8 \times 66 \mu F \times 650 kHz} = 3.23 mV$$

$$V_{RIPPLE} = 6mV + 3.23mV = 9.23mV$$

Output Transient Undershoot and Overshoot

In addition to voltage ripple at the switching frequency, the output capacitor and its ESR also affect the voltage sag (undershoot) and soar (overshoot) when the load steps up and down abruptly. The ACOT transient response is very quick and output transients are usually small.

However, the combination of small ceramic output capacitors (with little capacitance), low output voltages (with little stored charge in the output capacitors), and low duty cycle applications (which require high inductance to get reasonable ripple currents with high input voltages) increases the size of voltage variations in response to very quick load changes. Typically, load changes occur slowly with respect to the IC's 650kHz switching frequency.

But some modern digital loads can exhibit nearly instantaneous load changes and the following section shows how to calculate the worst-case voltage swings in response to very fast load steps.

The output voltage transient undershoot and overshoot each have two components: the voltage steps caused by the output capacitor's ESR, and the voltage sag and soar due

to the finite output capacitance and the inductor current slew rate. Use the following formulas to check if the ESR is low enough (typically not a problem with ceramic capacitors) and the output capacitance is large enough to prevent excessive sag and soar on very fast load step edges, with the chosen inductor value.

The amplitude of the ESR step up or down is a function of the load step and the ESR of the output capacitor:

$$V_{ESR_STEP} = \Delta I_{OUT} \times R_{ESR}$$

The amplitude of the capacitive sag is a function of the load step, the output capacitor value, the inductor value, the input-to-output voltage differential, and the maximum duty cycle. The maximum duty cycle during a fast transient is a function of the on-time and the minimum off-time since the ACOTTM control scheme will ramp the current using on-times spaced apart with minimum off-times, which is as fast as allowed. Calculate the approximate on-time (neglecting parasites) and maximum duty cycle for a given input and output voltage as:

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$$t_{ON}$$
 = $\frac{V_{OUT}}{V_{IN} \times f_{SW}}$ and D_{MAX} = $\frac{t_{ON}}{t_{ON} + t_{OFF_MIN}}$

The actual on-time will be slightly longer as the IC compensates for voltage drops in the circuit, but we can neglect both of these since the on-time increase compensates for the voltage losses. Calculate the output voltage sag as:

$$V_{SAG} = \frac{L \times (\Delta I_{OUT})^2}{2 \times C_{OUT} \times (V_{IN(MIN)} \times D_{MAX} - V_{OUT})}$$

The amplitude of the capacitive soar is a function of the load step, the output capacitor value, the inductor value and the output voltage:

$$V_{SOAR} = \frac{L \times (\Delta I_{OUT})^2}{2 \times C_{OUT} \times V_{OUT}}$$

For the Typical Operating Circuit for 1.2V output, the circuit has an inductor $1.5\mu H$ and $3 \times 22\mu F$ output capacitance with $5m\Omega$ ESR each. The ESR step is $6A \times 1.67m\Omega$ = 10mV which is small, as expected. The output voltage sag and soar in response to full 0A-6A-0A instantaneous transients are:

$$t_{ON} = \frac{1.2V}{12V \times 650 \text{kHz}} = 153 \text{ns}$$
 and $D_{MAX} = \frac{153 \text{ns}}{153 \text{ns} + 230 \text{ns}} = 0.399$

where 230ns is the minimum off time

$$V_{SAG} = \frac{1.5\mu H \times (6A)^2}{2 \times 66\mu F \times (12V \times 0.399 - 1.2V)} = 114\text{mV}$$

$$V_{SOAR} = \frac{1.5\mu H \times (6A)^2}{2 \times 66\mu F \times 1.2V} = 341\text{mV}$$

The sag is about 9.5% of the output voltage and the soar is a full 28.42% of the output voltage. The ESR step is negligible here but it does partially add to the soar, so keep that in mind whenever using higher-ESR output capacitors.

The soar is typically much worse than the sag in high input, low-output step-down converters because the high input voltage demands a large inductor value which stores lots of energy that is all transferred into the output if the load stops drawing current. Also, for a given inductor, the soar for a low output voltage is a greater voltage change and an even greater percentage of the output voltage.

Any sag is always short-lived, since the circuit quickly sources current to regain regulation in only a few switching

cycles. With the RT6236B, any overshoot transient is typically also short-lived since the converter will sink current, reversing the inductor current sharply until the output reaches regulation again. The RT6236A discontinuous operation at light loads prevents sinking current so, for that IC, the output voltage will soar until load current or leakage brings the voltage down to normal.

Most applications never experience instantaneous full load steps and the RT6236A/B high switching frequency and fast transient response can easily control voltage regulation at all times. Also, since the sag and soar both are proportional to the square of the load change, if load steps were reduced to 1A (from the 6A examples preceding) the voltage changes would be reduced by a factor of almost ten. For these reasons sag and soar are seldom an issue except in very low-voltage CPU core or DDR memory supply applications, particularly for devices with high clock frequencies and quick changes into and out of sleep modes. In such applications, simply increasing the amount of ceramic output capacitor (sag and soar are directly proportional to capacitance) or adding extra bulk capacitance can easily eliminate any excessive voltage transients.

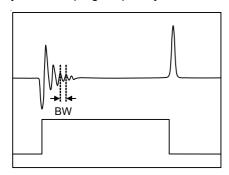
In any application with large quick transients, always calculate soar to make sure that over-voltage protection will not be triggered. Under-voltage is not likely since the threshold is very low (60%), that function has a long delay (250µs), and the IC will quickly return the output to regulation. Over-voltage protection has a minimum threshold of 120% and short delay of 10µs and can actually be triggered by incorrect component choices, particularly for the RT6236A which does not sink current.

Feed-forward Capacitor (Cff)

The RT6236A/B are optimized for ceramic output capacitors and for low duty cycle applications. However for high-output voltages, with high feedback attenuation, the circuit's response becomes over-damped and transient response can be slowed. In high-output voltage circuits (V_{OUT} > 3.3V) transient response is improved by adding a small "feed-forward" capacitor (Cff) across the upper FB divider resistor (Figure 1), to increase the circuit's Q and

reduce damping to speed up the transient response without affecting the steady-state stability of the circuit. Choose a suitable capacitor value that following below step.

• Get the BW the guickest method to do transient response form no load to full load. Confirm the damping frequency. The damping frequency is BW.



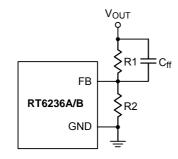


Figure 1. Cff Capacitor Setting

C_{ff} can be calculated base on below equation :

$$C_{ff} = \frac{1}{2 \times 3.1412 \times R1 \times BW \times 0.8}$$

Soft-Start (SS)

The RT6236A/B soft-start uses an external capacitor at SS to adjust the soft-start timing according to the following equation:

$$t (ms) = \frac{C_{SS}(nF) \times 0.7V}{I_{SS}(\mu A)}$$

Following below equation to get the minimum capacitance range in order to avoid UV occur.

$$T = \frac{C_{OUT} \times V_{OUT} \times 0.6 \times 1.2}{(I_{LIM} - Load Current) \times 0.8}$$

$$C_{SS} \ge \frac{T \times 6\mu A}{V_{PEF}}$$

Do not leave SS unconnected.

Enable Operation (EN)

For automatic start-up the low-voltage EN pin can be connected to VIN through a $100k\Omega$ resistor. Its large hysteresis band makes EN useful for simple delay and timing circuits. EN can be externally pulled to VIN by adding a resistor-capacitor delay (REN and CEN in Figure 2). Calculate the delay time using EN's internal threshold where switching operation begins.

An external MOSFET can be added to implement digital control of EN when no system voltage above 2V is available (Figure 3). In this case, a $100k\Omega$ pull-up resistor, R_{EN}, is connected between VIN and the EN pin. MOSFET Q1 will be under logic control to pull down the EN pin. To prevent enabling circuit when VIN is smaller than the VOUT target value or some other desired voltage level, a resistive voltage divider can be placed between the input voltage and ground and connected to EN to create an additional input under voltage lockout threshold (Figure 4).

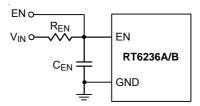


Figure 2. External Timing Control

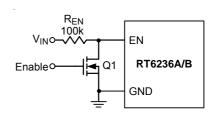


Figure 3. Digital Enable Control Circuit

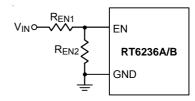


Figure 4. Resistor Divider for Lockout Threshold Setting



Output Voltage Setting

Set the desired output voltage using a resistive divider from the output to ground with the midpoint connected to FB. The output voltage is set according to the following equation:

$$V_{OUT} = 0.7V \times (1 + R1 / R2)$$

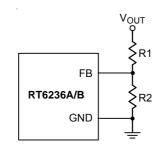


Figure 5. Output Voltage Setting

Place the FB resistors within 5mm of the FB pin. Choose R2 between $10k\Omega$ and $100k\Omega$ to minimize power consumption without excessive noise pick-up and calculate R1 as follows:

$$R1 = \frac{R2 \times (V_{OUT} - V_{REF})}{V_{REF}}$$

For output voltage accuracy, use divider resistors with 1% or better tolerance.

External BOOT Bootstrap Diode

When the input voltage is lower than 5.5V it is recommended to add an external bootstrap diode between VIN (or VINR) and the BOOT pin to improve enhancement of the internal MOSFET switch and improve efficiency. The bootstrap diode can be a low cost one such as 1N4148 or BAT54.

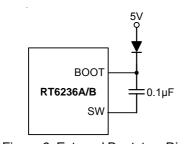


Figure 6. External Bootstrap Diode

External BOOT Capacitor Series Resistance

The internal power MOSFET switch gate driver is optimized to turn the switch on fast enough for low power loss and good efficiency, but also slow enough to reduce EMI. Switch turn-on is when most EMI occurs since V_{SW} rises rapidly. During switch turn-off, SW is discharged relatively slowly by the inductor current during the dead time between high-side and low-side switch on-times. In some cases it is desirable to reduce EMI further, at the expense of some additional power dissipation. The switch turn-on can be slowed by placing a small ($<47\Omega$) resistance between BOOT and the external bootstrap capacitor. This will slow the high-side switch turn-on and V_{SW}'s rise. To remove the resistor from the capacitor charging path (avoiding poor enhancement due to undercharging the BOOT capacitor), use the external diode shown in Figure 6 to charge the BOOT capacitor and place the resistance between BOOT and the capacitor/diode connection.

PVCC Capacitor Selection

Decouple PVCC to GND with a 1µF ceramic capacitor. High grade dielectric (X7R, or X5R) ceramic capacitors are recommended for their stable temperature and bias voltage characteristics.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and $\theta_{\text{JA}} \text{is the junction to ambient}$ thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For UQFN-13JL 2x3 (FC) package, the thermal resistance,



 θ_{JA} , is 64.8°C/W on a standard four-layer thermal test board. The maximum power dissipation at $T_A = 25^{\circ}C$ can be calculated by the following formula:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (64.8^{\circ}C/W) = 1.54W$ for UQFN-13JL 2x3 (FC) package

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance, $\theta_{\text{JA}}.$ The derating curve in Figure 7 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

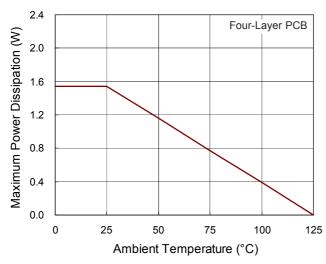


Figure 7. Derating Curve of Maximum Power Dissipation

Layout Consideration

- Follow the PCB layout guidelines for optimal performance of the device.
- Keep the traces of the main current paths as short and wide as possible.
- Put the input capacitor as close as possible to VIN and VIN pins.
- > SW node is with high frequency voltage swing and should be kept at small area. Keep analog components away from the SW node to prevent stray capacitive noise pickup.
- Connect feedback network behind the output capacitors. Keep the loop area small. Place the feedback components near the device.
- Connect all analog grounds to common node and then connect the common node to the power ground behind the output capacitors.
- ▶ An example of PCB layout guide is shown in Figure 8 for reference.

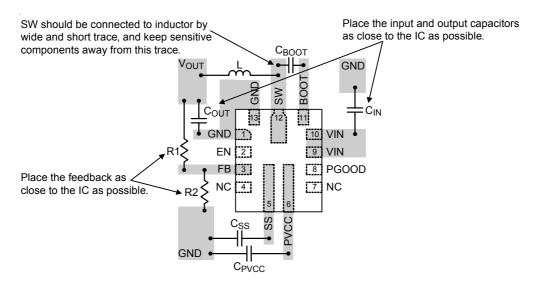
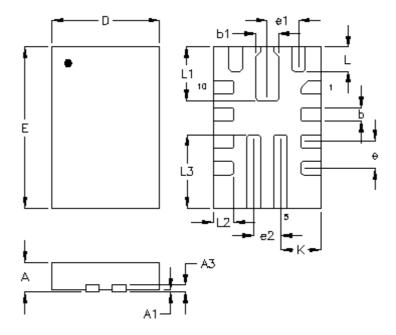


Figure 8. PCB Layout Guide



Outline Dimension



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	0.500	0.600	0.020	0.024	
A1	0.000	0.050	0.000	0.002	
A3	0.100	0.152	0.004	0.006	
b	0.200	0.300	0.008	0.012	
b1	0.370	0.470	0.015	0.019	
D	1.900	2.100	0.075	0.083	
E	2.900	3.100	0.114	0.122	
К	0.7	750	0.030		
е	0.5	500	0.020		
e1	0.5	585	0.023		
e2	0.500		0.0	20	
L	0.400	0.500	0.016	0.020	
L1	0.950	1.050	0.037	0.041	
L2	0.325	0.425	0.013	0.017	
L3	1.325	1.425	0.052	0.056	

U-Type 13JL QFN 2x3 (FC) Package

RT6236A/B



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IR35215MTRPBF SG3845DM NCP4204MNTXG NCP6132AMNR2G NCP81102MNTXG NCP81206MNTXG UBA2051C NCP1240AD065R2G NCP1240FD065R2G NCP1361BABAYSNT1G NCP1230P100G NX2124CSTR SG2845M NCP1366BABAYDR2G NCP81101MNTXG TEA19362T/1J NCP81174NMNTXG NCP4308DMTTWG NCP4308DMNTWG NCP4308AMTTWG NCP1366AABAYDR2G NCP1251FSN65T1G NCP1246BLD065R2G iW1760B-10 MB39A136PFT-G-BND-ERE1 NCP1256BSN100T1G LV5768V-A-TLM-E NCP1365BABCYDR2G NCP1365AABCYDR2G MCP1633T-E/MG MCP1633-E/MG NCV1397ADR2G NCP81599MNTXG NCP1246ALD065R2G AZ494AP-E1 NCP1247BD065R2G